Справочный раздел Интернет Портала «Радиодар»

# ТЕХНИЧЕСКИЙ СПРАВОЧНИК «Мощный БТИЗ (IGBT) транзистор FGH40N60UFD производства фирмы ON Semiconductor»

	Версия:	1
	Ревизия:	2
	Дата:	28.01.2020
РАДИОДАР. интернет-магазин радиотоваров		
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«Радиодар» 2020

# **IGBT - Field Stop**

600 V, 40 A

# FGH40N60UFD

#### Description

Using novel Field Stop IGBT technology, ON Semiconductor's field stop IGBTs offer the optimum performance for solar inverter, UPS, welder, microwave oven, telecom, ESS and PFC applications where low conduction and switching losses are essential.

#### Features

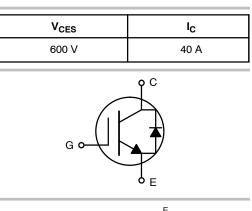
- High Current Capability
- Low Saturation Voltage:  $V_{CE(sat)} = 1.8 \text{ V} @ \text{ I}_{C} = 40 \text{ A}$
- High Input Impedance
- Fast Switching
- This Device is Pb-Free and is RoHS Compliant

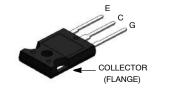
#### Applications

• Solar Inverter, UPS, Welder, PFC, Microwave Oven, Telecom, ESS



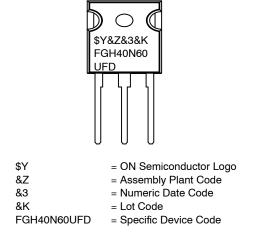
# **ON Semiconductor®**





TO-247-3LD CASE 340CK

#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

See detailed ordering and shipping information on page 2 of this data sheet.

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Description		Ratings	Unit	
V <sub>CES</sub>	Collector to Emitter Voltage		600	V	
V <sub>GES</sub>	Gate to Emitter Voltage Transient Gate-to-Emitter Voltage		±20	V	
			±30	V	
Ι <sub>C</sub>	Collector Current T <sub>C</sub> :	= 25°C	80	А	
	T <sub>C</sub> =	= 100°C	40	А	
I <sub>CM</sub> (Note 1)	Pulsed Collector Current T <sub>C</sub> :	= 25°C	120	А	
PD	Maximum Power Dissipation $T_C = 25^{\circ}C$		290	W	
	T <sub>C</sub> =	= 100°C	116	W	
TJ	Operating Junction Temperature		-55 to +150	°C	
T <sub>STG</sub>	Storage Temperature Range		-55 to +150	°C	
TL	Maximum Lead Temp. for Soldering Purposes, 1/8"	from Case for 5 Seconds	300	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 1. Repetitive rating: Pulse width limited by max. junction temperature.

#### **THERMAL CHARACTERISTICS**

Symbol	Parameter	Тур.	Max.	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case	-	0.43	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case	-	1.45	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	-	40	°C/W

### PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Qty per Tube
FGH40N60UFDTU	FGH40N60UFD	TO-247	Tube	N/A	N/A	30

#### ELECTRICAL CHARACTERISTICS OF THE IGBT (T<sub>C</sub> = 25°C unless otherwise noted)

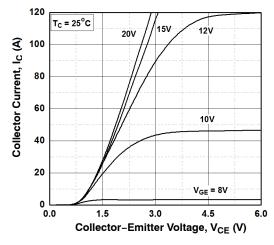
Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
OFF CHARAC	TERISTICS	•	•			
BV <sub>CES</sub>	Collector to Emitter Breakdown Voltage	$V_{GE}$ = 0 V, $I_{C}$ = 250 $\mu$ A	600	-	-	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	V <sub>GE</sub> = 0 V, I <sub>C</sub> = 250 μA	-	0.6	-	V/°C
I <sub>CES</sub>	Collector Cut-Off Current	V <sub>CE</sub> = V <sub>CES</sub> , V <sub>GE</sub> = 0 V	-	_	250	μA
I <sub>GES</sub>	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
N CHARACT	ERISTICS					
V <sub>GE(th)</sub>	G-E Threshold Voltage	$I_C$ = 250 $\mu$ A, $V_{CE}$ = $V_{GE}$	4.0	5.0	6.5	V
V <sub>CE(sat)</sub>	V <sub>CE(sat)</sub> Collector to Emitter Saturation Voltage	I <sub>C</sub> = 40 A, V <sub>GE</sub> = 15 V,	_	1.8	2.4	V
		$I_{C}$ = 40 A, $V_{GE}$ = 15 V, $T_{C}$ = 125°C	-	2.0	-	v
YNAMIC CHA	ARACTERISTICS			<b>.</b>		
C <sub>ies</sub>	Input Capacitance	V <sub>CE</sub> = 30 V, V <sub>GE</sub> = 0 V,	_	2110	_	pF
C <sub>oes</sub>	Output Capacitance	f = 1 MHz	_	200	-	pF
C <sub>res</sub>	Reverse Transfer Capacitance	-	-	60	-	pF
WITCHING C	HARACTERISTICS		•			
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{\rm CC} = 400 \text{ V}, \text{ I}_{\rm C} = 40 \text{ A},$	-	24	-	ns
T <sub>r</sub>	Rise Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 25$ °C	-	44	-	ns
T <sub>d(off)</sub>	Turn-Off Delay Time		-	112	-	ns
Τ <sub>f</sub>	Fall Time		-	30	60	ns
Eon	Turn–On Switching Loss		-	1.19	-	mJ
E <sub>off</sub>	Turn–Off Switching Loss		-	0.46	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	1.65	-	mJ
T <sub>d(on)</sub>	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 40 \text{ A},$	-	24	-	ns
T <sub>r</sub>	Rise Time	$R_G = 10 \Omega$ , $V_{GE} = 15 V$ , Inductive Load, $T_C = 125$ °C	-	45	-	ns
T <sub>d(off)</sub>	Turn-Off Delay Time		-	120	-	ns
Τ <sub>f</sub>	Fall Time	1	-	40	-	ns
Eon	Turn-On Switching Loss	1	-	1.2	-	mJ
E <sub>off</sub>	Turn-Off Switching Loss	-	-	0.69	-	mJ
E <sub>ts</sub>	Total Switching Loss		-	1.89	-	mJ
Qg	Total Gate Charge	$V_{CE} = 400 \text{ V}, I_C = 40 \text{ A},$	-	120	-	nC
Q <sub>ge</sub>	Gate to Emitter Charge	$V_{GE} = 15 V$	-	14	-	nC
Q <sub>gc</sub>	Gate to Collector Charge	1	_	58	_	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Symbol	Parameter	Test Conditions		Min	Тур	Max	Unit
V <sub>FM</sub>	Diode Forward Voltage	I <sub>F</sub> = 20 A	$T_{C} = 25^{\circ}C$	-	1.95	2.6	V
			T <sub>C</sub> = 125°C	-	1.85	-	
T <sub>rr</sub>	Diode Reverse Recovery Time	I <sub>F</sub> = 20 A, di <sub>F</sub> /dt = 200 A/μs	$T_{C} = 25^{\circ}C$	-	45	-	ns
		αι <sub>F</sub> /αι – 200 Α/μ3	T <sub>C</sub> = 125°C	-	140	-	
Q <sub>rr</sub>	Diode Reverse Recovery Charge	]	$T_C = 25^{\circ}C$	-	75	-	nC
			$T_C = 125^{\circ}C$	-	375	-	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

#### **TYPICAL PERFORMANCE CHARACTERISTICS**



**Figure 1. Typical Output Characteristics** 

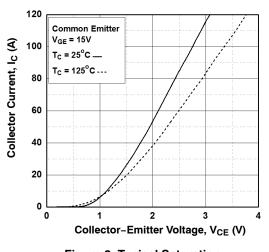


Figure 3. Typical Saturation Voltage Characteristics

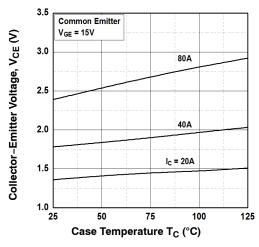
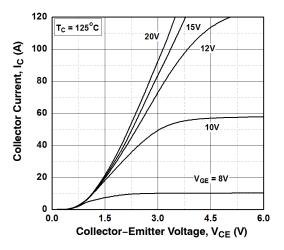
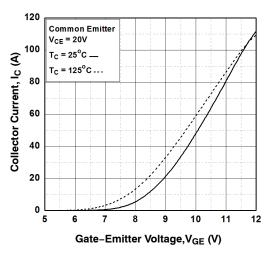


Figure 5. Saturation Voltage vs. Case Temperature at Variant Current Level



**Figure 2. Typical Output Characteristics** 



**Figure 4. Transfer Characteristics** 

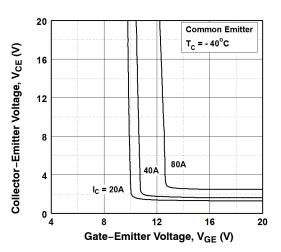


Figure 6. Saturation Voltage vs. V<sub>GE</sub>

#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

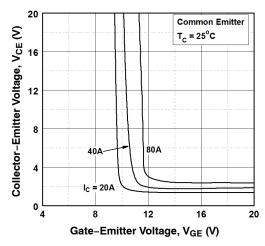


Figure 7. Saturation Voltage vs V<sub>GE</sub>

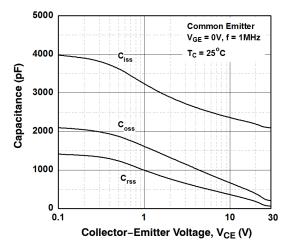
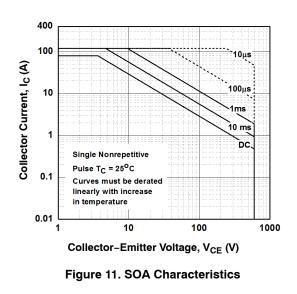


Figure 9. Capacitance Characteristics



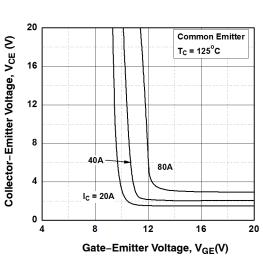


Figure 8. Saturation Voltage vs V<sub>GE</sub>

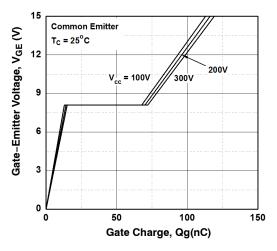
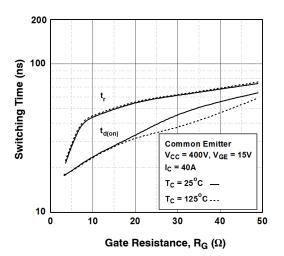
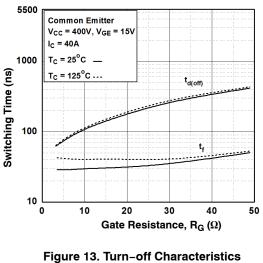


Figure 10. Gate Charge Characteristics





#### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)



vs. Gate Resistance

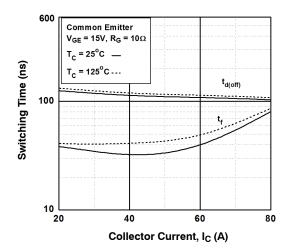


Figure 15. Turn-off Characteristics vs. Collector Current

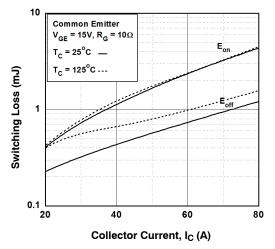
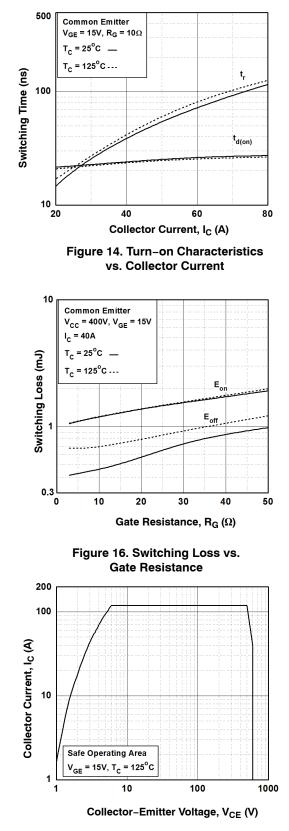
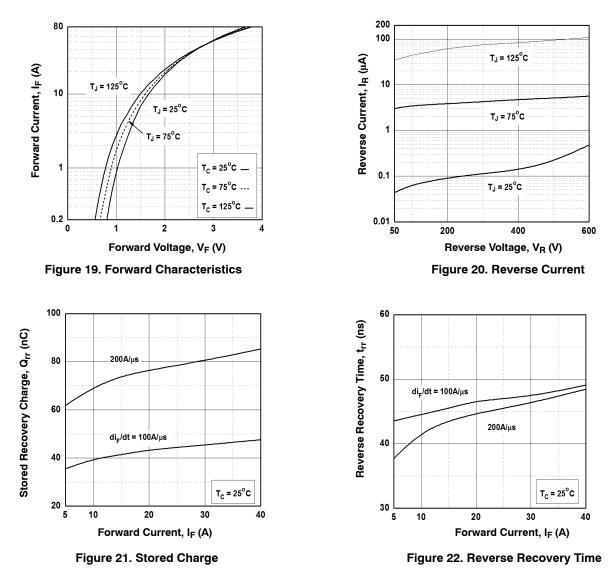


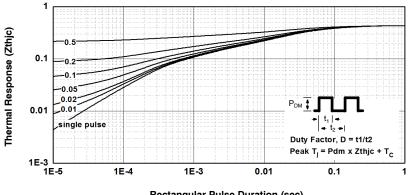
Figure 17. Switching Loss vs. Collector Current





### TYPICAL PERFORMANCE CHARACTERISTICS (Continued)





**Rectangular Pulse Duration (sec)** 

Figure 23. Transient Thermal Impedance of IGBT





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